

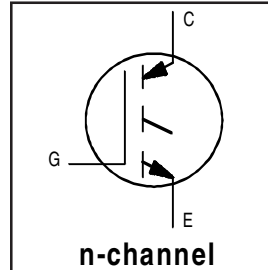
IRG4BC10K

INSULATED GATE BIPOLAR TRANSISTOR

Short Circuit Rated
UltraFast IGBT

Features

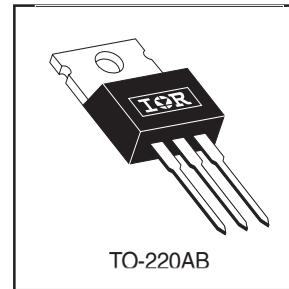
- Short Circuit Rated UltraFast: Optimized for high operating frequencies >5.0 kHz , and Short Circuit Rated to 10 μ s @ 125°C, V_{GE} = 15V
- Generation 4 IGBT design provides higher efficiency than Generation 3
- Industry standard TO-220AB package



| |
|--|
| V _{CES} = 600V |
| V _{CE(on)} typ. = 2.39V |
| @ V _{GE} = 15V, I _C = 5.0A |

Benefits

- Generation 4 IGBTs offer highest efficiency available
- IGBTs optimized for specified application conditions



Absolute Maximum Ratings

| | Parameter | Max. | Units |
|---|--|--------------------|---------|
| V _{CES} | Collector-to-Emitter Breakdown Voltage | 600 | V |
| I _C @ T _C = 25°C | Continuous Collector Current | 9.0 | A |
| I _C @ T _C = 100°C | Continuous Collector Current | 5.0 | |
| I _{CM} | Pulsed Collector Current ① | 18 | |
| I _{LM} | Clamped Inductive Load Current ② | 18 | |
| t _{sc} | Short Circuit Withstand Time | 10 | μ s |
| V _{GE} | Gate-to-Emitter Voltage | \pm 20 | V |
| E _{ARV} | Reverse Voltage Avalanche Energy ③ | 34 | mJ |
| P _D @ T _C = 25°C | Maximum Power Dissipation | 38 | W |
| P _D @ T _C = 100°C | Maximum Power Dissipation | 15 | |
| T _J | Operating Junction and Storage Temperature Range | -55 to + 150 | °C |
| T _{STG} | | | |
| | | | |
| | Mounting torque, 6-32 or M3 screw. | 10 lbf•in (1.1N•m) | |

Thermal Resistance

| | Parameter | Typ. | Max. | Units |
|------------------|---|------------|------|--------|
| R _{θJC} | Junction-to-Case | — | 3.3 | °C/W |
| R _{θCS} | Case-to-Sink, Flat, Greased Surface | 0.5 | — | |
| R _{θJA} | Junction-to-Ambient, typical socket mount | — | 80 | |
| Wt | Weight | 2.0 (0.07) | — | g (oz) |

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Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|---------------------------------|--|------|------|-----------|---------|---|
| $V_{(BR)CES}$ | Collector-to-Emitter Breakdown Voltage | 600 | — | — | V | $V_{GE} = 0V, I_C = 250\mu A$ |
| $V_{(BR)ECS}$ | Emitter-to-Collector Breakdown Voltage ④ | 18 | — | — | V | $V_{GE} = 0V, I_C = 1.0A$ |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage | — | 0.58 | — | V/°C | $V_{GE} = 0V, I_C = 1.0mA$ |
| $V_{CE(ON)}$ | Collector-to-Emitter Saturation Voltage | — | 2.39 | 2.62 | V | $I_C = 5.0A, V_{GE} = 15V$ |
| | | — | 3.25 | — | | $I_C = 9.0A$ |
| | | — | 2.63 | — | | $I_C = 5.0A, T_J = 150^\circ\text{C}$ |
| $V_{GE(th)}$ | Gate Threshold Voltage | 3.0 | — | 6.5 | | $V_{CE} = V_{GE}, I_C = 250\mu A$ |
| $\Delta V_{GE(th)}/\Delta T_J$ | Temperature Coeff. of Threshold Voltage | — | -11 | — | mV/°C | $V_{CE} = V_{GE}, I_C = 250\mu A$ |
| g_{fe} | Forward Transconductance ⑤ | 1.2 | 1.8 | — | S | $V_{CE} = 50V, I_C = 5.0A$ |
| I_{CES} | Zero Gate Voltage Collector Current | — | — | 250 | μA | $V_{GE} = 0V, V_{CE} = 600V$ |
| | | — | — | 2.0 | | $V_{GE} = 0V, V_{CE} = 10V, T_J = 25^\circ\text{C}$ |
| | | — | — | 1000 | | $V_{GE} = 0V, V_{CE} = 600V, T_J = 150^\circ\text{C}$ |
| I_{GES} | Gate-to-Emitter Leakage Current | — | — | ± 100 | nA | $V_{GE} = \pm 20V$ |

Switching Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

| | Parameter | Min. | Typ. | Max. | Units | Conditions |
|--------------|-----------------------------------|------|------|------|---------|--|
| Q_g | Total Gate Charge (turn-on) | — | 19 | 29 | nC | $I_C = 5.0A$ |
| Q_{ge} | Gate - Emitter Charge (turn-on) | — | 2.9 | 4.3 | | $V_{CC} = 400V$ |
| Q_{gc} | Gate - Collector Charge (turn-on) | — | 9.8 | 15 | | $V_{GE} = 15V$ |
| $t_{d(on)}$ | Turn-On Delay Time | — | 11 | — | ns | $T_J = 25^\circ\text{C}$ $I_C = 5.0A, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 100\Omega$ |
| t_r | Rise Time | — | 24 | — | | |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 51 | 77 | | |
| t_f | Fall Time | — | 190 | 290 | | |
| E_{on} | Turn-On Switching Loss | — | 0.16 | — | mJ | Energy losses include "tail" See Fig. 9,10,14 |
| E_{off} | Turn-Off Switching Loss | — | 0.10 | — | | |
| E_{ts} | Total Switching Loss | — | 0.26 | 0.32 | | |
| t_{sc} | Short Circuit Withstand Time | 10 | — | — | μs | $V_{CC} = 400V, T_J = 125^\circ\text{C}$ $V_{GE} = 15V, R_G = 100\Omega, V_{CPK} < 500V$ |
| $t_{d(on)}$ | Turn-On Delay Time | — | 11 | — | ns | $T_J = 150^\circ\text{C}$, $I_C = 5.0A, V_{CC} = 480V$ $V_{GE} = 15V, R_G = 100\Omega$ Energy losses include "tail" See Fig. 10,11,14 |
| t_r | Rise Time | — | 27 | — | | |
| $t_{d(off)}$ | Turn-Off Delay Time | — | 67 | — | | |
| t_f | Fall Time | — | 350 | — | | |
| E_{ts} | Total Switching Loss | — | 0.47 | — | mJ | |
| L_E | Internal Emitter Inductance | — | 7.5 | — | nH | Measured 5mm from package |
| C_{ies} | Input Capacitance | — | 220 | — | pF | $V_{GE} = 0V$ $V_{CC} = 30V$ |
| C_{oes} | Output Capacitance | — | 29 | — | | |
| C_{res} | Reverse Transfer Capacitance | — | 7.5 | — | | |

Notes:

- ① Repetitive rating; $V_{GE} = 20V$, pulse width limited by max. junction temperature. (See fig. 13b)
- ② $V_{CC} = 80\%(V_{CES})$, $V_{GE} = 20V$, $L = 10\mu H$, $R_G = 100\Omega$, (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width $\leq 80\mu s$; duty factor $\leq 0.1\%$.
- ⑤ Pulse width $5.0\mu s$, single shot.

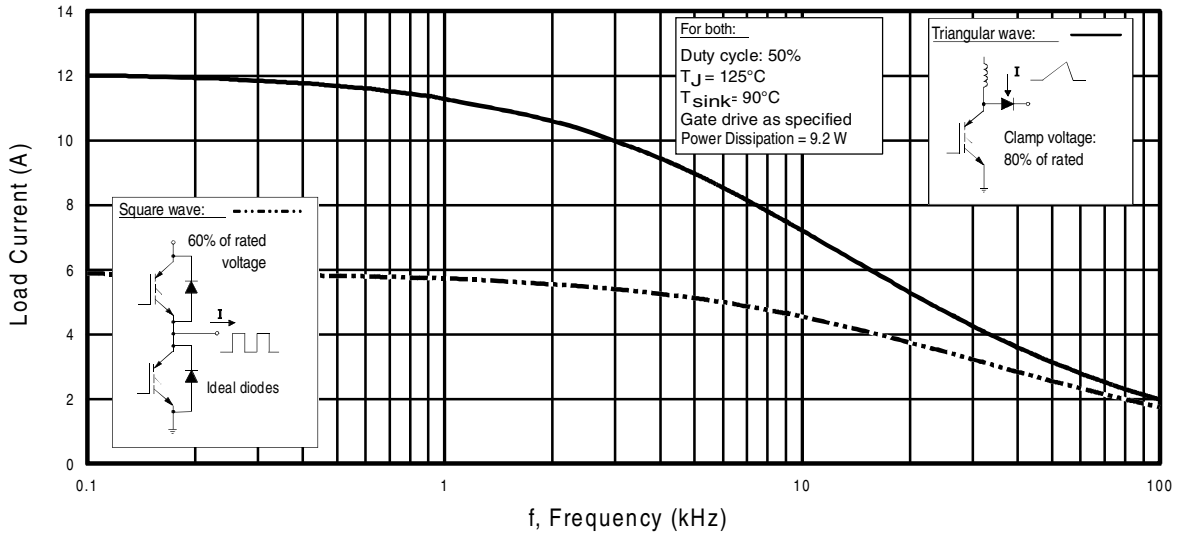


Fig. 1 - Typical Load Current vs. Frequency
(Load Current = I_{RMS} of fundamental)

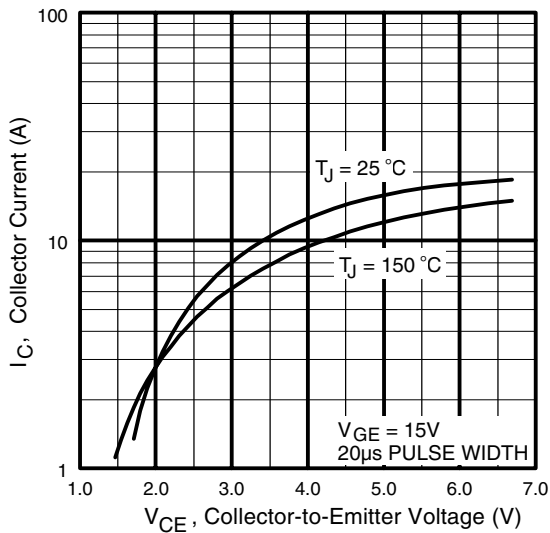


Fig. 2 - Typical Output Characteristics

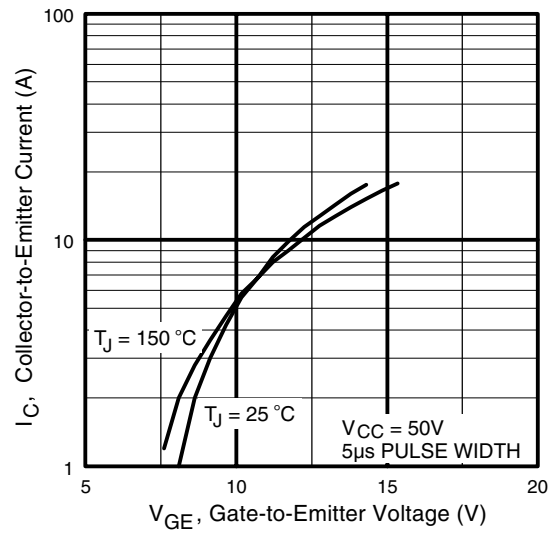


Fig. 3 - Typical Transfer Characteristics

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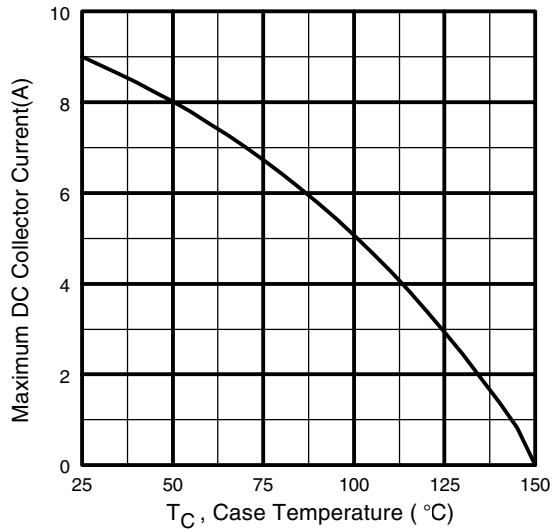


Fig. 4 - Maximum Collector Current vs. Case Temperature

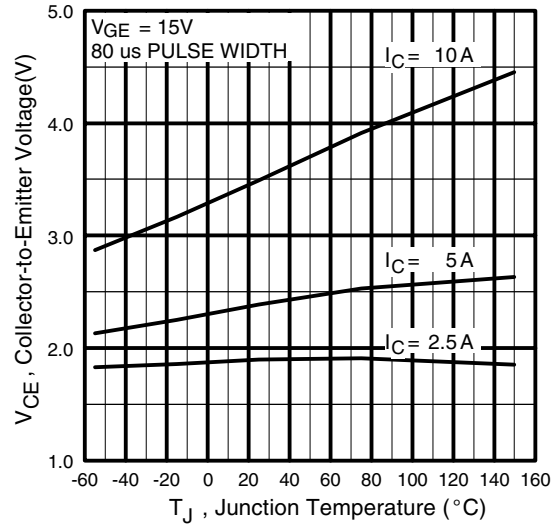


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

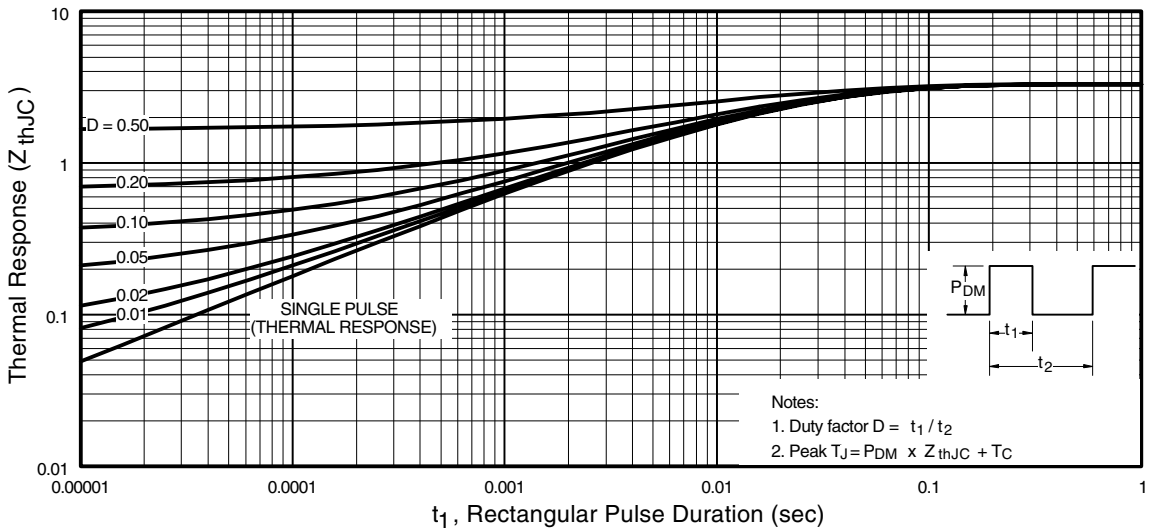


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

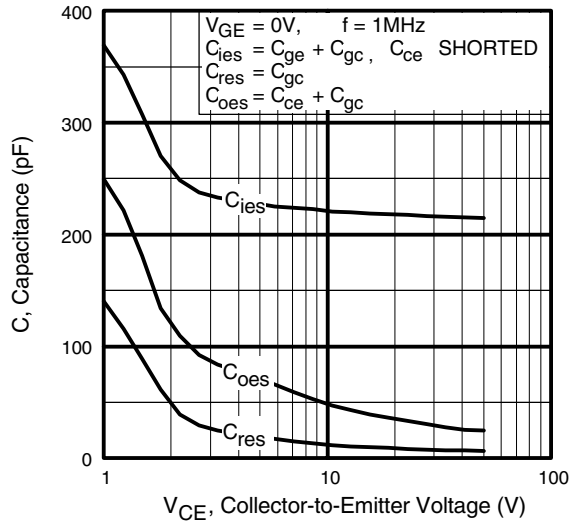


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

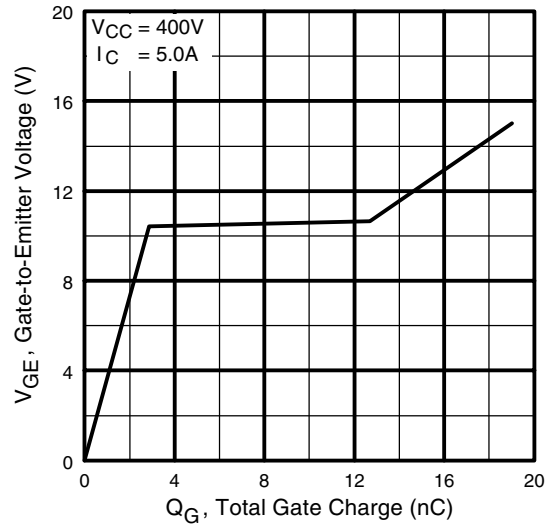


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

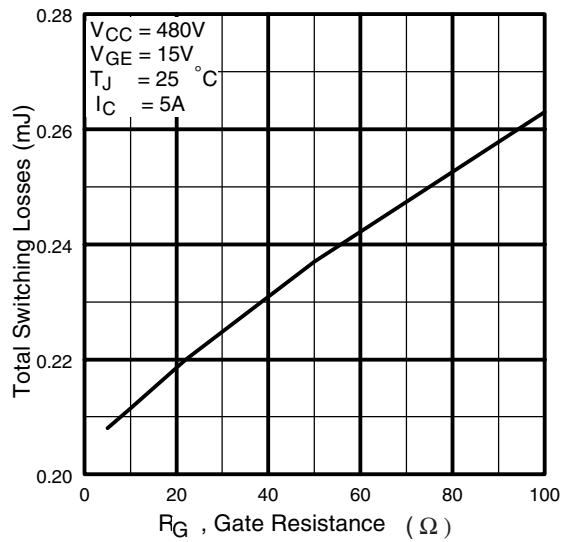


Fig. 9 - Typical Switching Losses vs. Gate Resistance

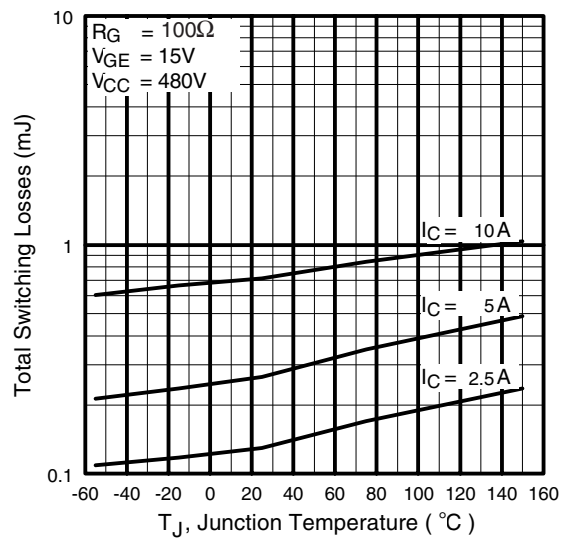


Fig. 10 - Typical Switching Losses vs. Junction Temperature

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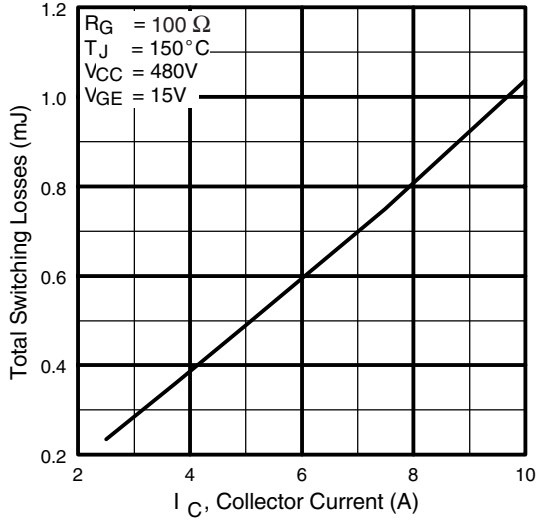


Fig. 11 - Typical Switching Losses vs. Collector Current

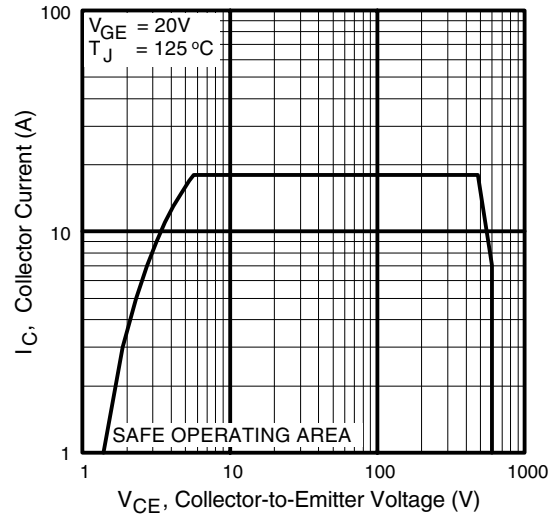


Fig. 12 - Turn-Off SOA

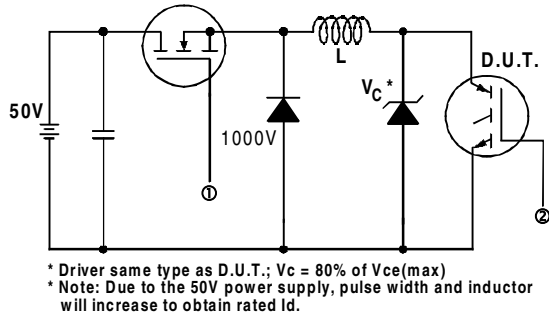


Fig. 13a - Clamped Inductive Load Test Circuit

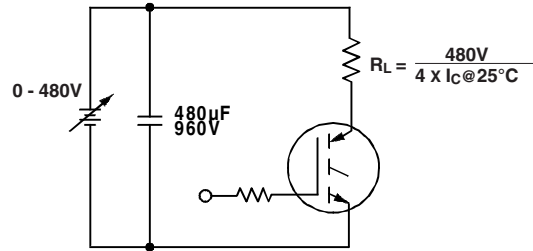


Fig. 13b - Pulsed Collector Current Test Circuit

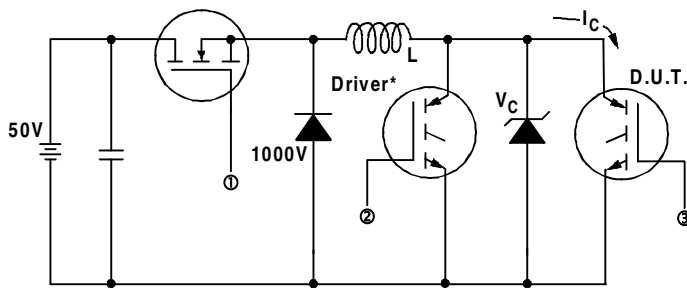


Fig. 14a - Switching Loss Test Circuit

* Driver same type as D.U.T., $V_c = 480V$

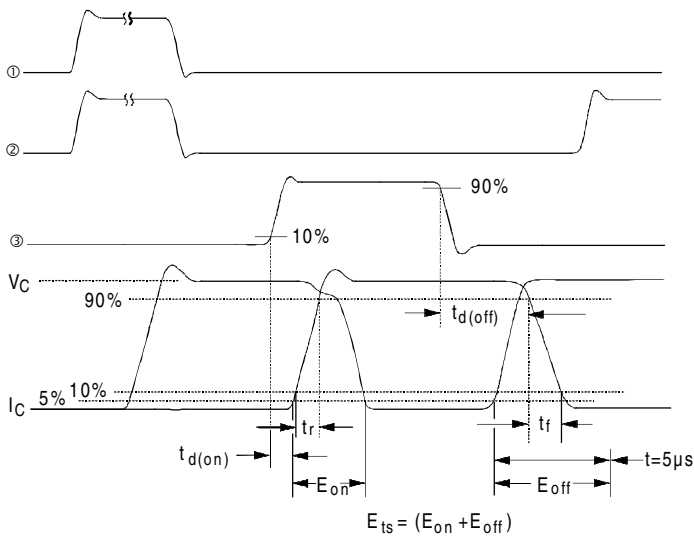
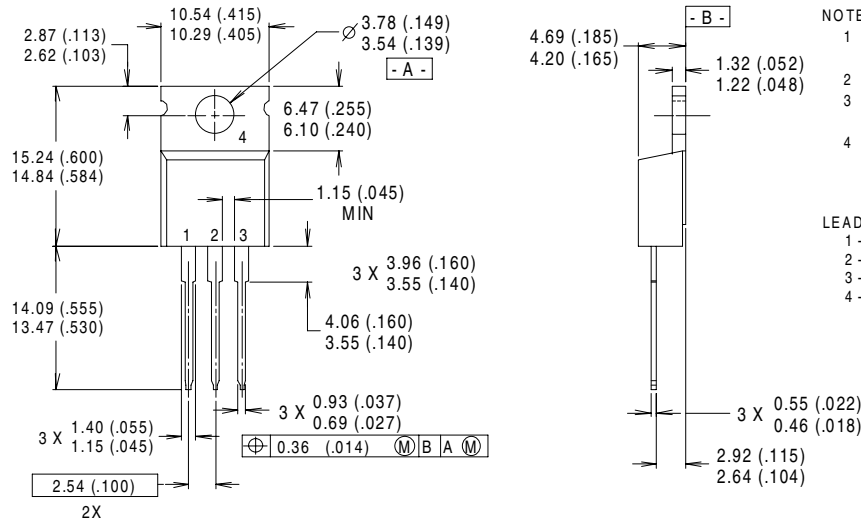


Fig. 14b - Switching Loss Waveforms

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International
IR Rectifier

Case Outline and Dimensions — TO-220AB



NOTES:

- 1 DIMENSIONS & TOLERANCING PER ANSI Y14.5M, 1982.
- 2 CONTROLLING DIMENSION : INCH.
- 3 DIMENSIONS ARE SHOWN MILLIMETERS (INCHES).
- 4 CONFORMS TO JEDEC OUTLINE TO-220AB.

LEAD ASSIGNMENTS

- 1 - GATE
- 2 - COLLECTOR
- 3 - EMITTER
- 4 - COLLECTOR

CONFORMS TO JEDEC OUTLINE TO-220AB

Dimensions in Millimeters and (Inches)

International
IR Rectifier

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Data and specifications subject to change without notice. 4/00

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